

# 100331 Low Power Triple D Flip-Flop

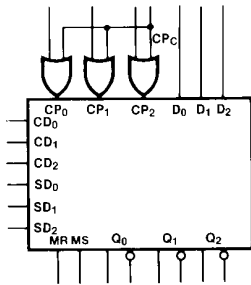
## General Description

The 100331 contains three D-type, edge-triggered master/slave flip-flops with true and complement outputs, a Common Clock (CP<sub>C</sub>), and Master Set (MS) and Master Reset (MR) inputs. Each flip-flop has individual Clock (CP<sub>n</sub>), Direct Set (SD<sub>n</sub>) and Direct Clear (CD<sub>n</sub>) inputs. Data enters a master when both CP<sub>n</sub> and CP<sub>C</sub> are LOW and transfers to a slave when CP<sub>n</sub> or CP<sub>C</sub> (or both) go HIGH. The Master Set, Master Reset and individual CD<sub>n</sub> and SD<sub>n</sub> inputs override the Clock inputs. All inputs have 50 kΩ pull-down resistors.

## Features

- 35% power reduction of the 100131
- 2000V ESD protection
- Pin/function compatible with 100131
- Voltage compensated operating range = -4.2V to -5.7V
- Available to industrial grade temperature range
- Available to MIL-STD-883

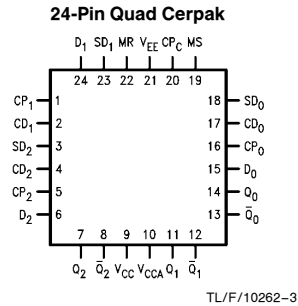
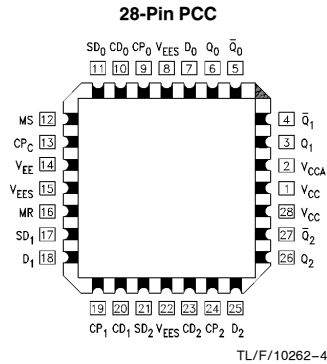
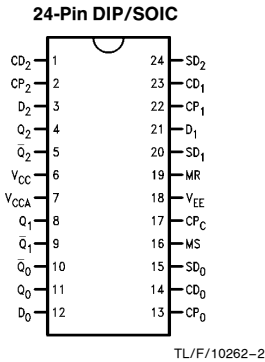
## Logic Symbol



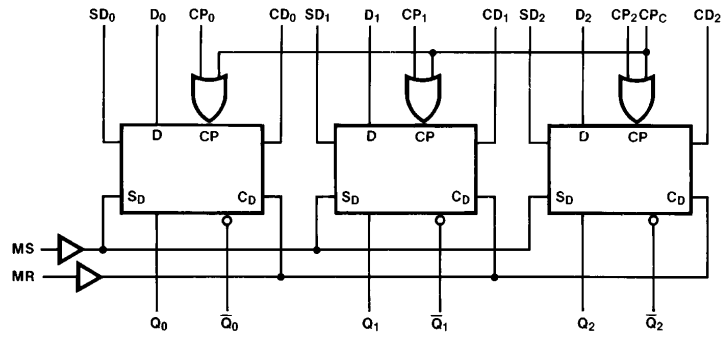
TL/F/10262-1

Pin Names	Description
CP <sub>0</sub> -CP <sub>2</sub>	Individual Clock Inputs
CP <sub>C</sub>	Common Clock Input
D <sub>0</sub> -D <sub>2</sub>	Data Inputs
CD <sub>0</sub> -CD <sub>2</sub>	Individual Direct Clear Inputs
SD <sub>n</sub>	Individual Direct Set Inputs
MR	Master Reset Input
MS	Master Set Input
Q <sub>0</sub> -Q <sub>2</sub>	Data Outputs
$\bar{Q}_0$ - $\bar{Q}_2$	Complementary Data Outputs

## Connection Diagrams



## Logic Diagram



TL/F/10262-5

## Truth Tables (Each Flip-Flop)

### Synchronous Operation

Inputs					Outputs
$D_n$	$CP_n$	$CP_C$	$MS$ $SD_n$	$MR$ $CD_n$	$Q_n(t + 1)$
L	↗	L	L	L	L
H	↗	L	L	L	H
L	L	↗	L	L	L
H	L	↗	L	L	H
X	L	L	L	L	$Q_n(t)$
X	H	X	L	L	$Q_n(t)$
X	X	H	L	L	$Q_n(t)$

### Asynchronous Operation

Inputs					Outputs
$D_n$	$CP_n$	$CP_C$	$MS$ $SD_n$	$MR$ $CD_n$	$Q_n(t + 1)$
X	X	X	H	L	H
X	X	X	L	H	L
X	X	X	H	H	U

H = HIGH Voltage Level  
 L = LOW Voltage Level  
 X = Don't Care  
 U = Undefined  
 t = Time before CP Positive Transition  
 t + 1 = Time after CP Positive Transition  
 ↗ = LOW to HIGH Transition

## Absolute Maximum Ratings

Above which the useful life may be impaired (Note 1)

**If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.**

Storage Temperature ( $T_{STG}$ )  $-65^{\circ}\text{C}$  to  $+150^{\circ}\text{C}$

Maximum Junction Temperature ( $T_J$ )  
 Ceramic  $+175^{\circ}\text{C}$   
 Plastic  $+150^{\circ}\text{C}$

Pin Potential to Ground Pin ( $V_{EE}$ )  $-7.0\text{V}$  to  $+0.5\text{V}$

Input Voltage (DC)  $V_{EE}$  to  $+0.5\text{V}$

Output Current (DC Output HIGH)  $-50\text{ mA}$

ESD (Note 2)  $\leq 2000\text{V}$

**Note 1:** Absolute maximum ratings are those values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

**Note 2:** ESD testing conforms to MIL-STD-883, Method 3015.

## Commercial Version

### DC Electrical Characteristics

$V_{EE} = -4.2\text{V}$  to  $-5.7\text{V}$ ,  $V_{CC} = V_{CCA} = \text{GND}$ ,  $T_C = 0^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  (Note 3)

Symbol	Parameter	Min	Typ	Max	Units	Conditions	
$V_{OH}$	Output HIGH Voltage	$-1025$	$-955$	$-870$	mV	$V_{IN} = V_{IH}(\text{Max})$ or $V_{IL}(\text{Min})$	Loading with $50\Omega$ to $-2.0\text{V}$
$V_{OL}$	Output LOW Voltage	$-1830$	$-1705$	$-1620$	mV		
$V_{OHC}$	Output HIGH Voltage	$-1035$			mV	$V_{IN} = V_{IH}(\text{Min})$ or $V_{IL}(\text{Max})$	Loading with $50\Omega$ to $-2.0\text{V}$
$V_{OLC}$	Output LOW Voltage			$-1610$	mV		
$V_{IH}$	Input HIGH Voltage	$-1165$		$-870$	mV	Guaranteed HIGH Signal for All Inputs	
$V_{IL}$	Input LOW Voltage	$-1830$		$-1475$	mV	Guaranteed LOW Signal for All Inputs	
$I_{IL}$	Input LOW Current	0.5			$\mu\text{A}$	$V_{IN} = V_{IL}(\text{Min})$	
$I_{IH}$	Input HIGH Current			240	$\mu\text{A}$	$V_{IN} = V_{IH}(\text{Max})$	
$I_{EE}$	Power Supply Current	$-122$		$-65$	mA	Inputs Open	

**Note 3:** The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

## Recommended Operating Conditions

Case Temperature ( $T_C$ )  
 Commercial  $0^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$   
 Industrial  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$   
 Military  $-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$   
 Supply Voltage ( $V_{EE}$ )  $-5.7\text{V}$  to  $-4.2\text{V}$

**Commercial Version** (Continued)

**DIP AC Electrical Characteristics**

$V_{EE} = -4.2V$  to  $-5.7V$ ,  $V_{CC} = V_{CCA} = GND$  (Continued)

Symbol	Parameter	$T_C = 0^\circ C$		$T_C = +25^\circ C$		$T_C = +85^\circ C$		Units	Conditions	
		Min	Max	Min	Max	Min	Max			
$f_{max}$	Toggle Frequency	375		375		375		MHz	Figures 2 and 3	
$t_{PLH}$ $t_{PHL}$	Propagation Delay $CP_C$ to Output	0.75	2.00	0.75	2.00	0.75	2.00	ns	Figures 1 and 3	
$t_{PLH}$ $t_{PHL}$	Propagation Delay $CP_n$ to Output	0.75	2.00	0.75	2.00	0.75	2.00	ns		
$t_{PLH}$ $t_{PHL}$	Propagation Delay $CD_n, SD_n$ to Output	0.70	1.70	0.70	1.70	0.70	1.80	ns	$CP_n, CP_C = L$	Figures 1 and 4
$t_{PLH}$ $t_{PHL}$		0.70	2.00	0.70	2.00	0.70	2.00		$CP_n, CP_C = H$	
$t_{PLH}$ $t_{PHL}$	Propagation Delay MS, MR to Output	1.10	2.60	1.10	2.60	1.10	2.60	ns	$CP_n, CP_C = L$	
$t_{PLH}$ $t_{PHL}$		1.10	2.80	1.10	2.80	1.10	2.80		$CP_n, CP_C = H$	
$t_{TLH}$ $t_{THL}$	Transition Time 20% to 80%, 80% to 20%	0.35	1.30	0.35	1.30	0.35	1.30	ns	Figures 1, 3 and 4	
$t_S$	Setup Time $D_n$	0.40		0.40		0.40		ns	Figure 5	
	$CD_n, SD_n$ (Release Time)	1.30		1.30		1.30			Figure 4	
	MS, MR (Release Time)	2.30		2.30		2.30				
$t_H$	Hold Time $D_n$	0.5		0.5		0.7		ns	Figure 5	
$t_{pw}(H)$	Pulse Width HIGH $CP_n, CP_C, CD_n,$ $SD_n, MR, MS$	2.00		2.00		2.00		ns	Figures 3 and 4	

**SOIC, PCC and Cerpak AC Electrical Characteristics**

$V_{EE} = -4.2V$  to  $-5.7V$ ,  $V_{CC} = V_{CCA} = GND$

Symbol	Parameter	$T_C = 0^\circ C$		$T_C = +25^\circ C$		$T_C = +85^\circ C$		Units	Conditions	
		Min	Max	Min	Max	Min	Max			
$f_{max}$	Toggle Frequency	400		400		400		MHz	Figures 2 and 3	
$t_{PLH}$ $t_{PHL}$	Propagation Delay $CP_C$ to Output	0.75	1.80	0.75	1.80	0.75	1.80	ns	Figures 1 and 3	
$t_{PLH}$ $t_{PHL}$	Propagation Delay $CP_n$ to Output	0.75	1.80	0.75	1.80	0.75	1.80	ns		
$t_{PLH}$ $t_{PHL}$	Propagation Delay $CD_n, SD_n$ to Output	0.70	1.50	0.70	1.50	0.70	1.60	ns	$CP_n, CP_C = L$	Figures 1 and 4
$t_{PLH}$ $t_{PHL}$		0.80	1.80	0.70	1.80	0.70	1.80		$CP_n, CP_C = H$	
$t_{PLH}$ $t_{PHL}$	Propagation Delay MS, MR to Output	1.10	2.40	1.10	2.40	1.10	2.40	ns	$CP_n, CP_C = L$	
$t_{PLH}$ $t_{PHL}$		1.10	2.60	1.10	2.60	1.10	2.60		$CP_n, CP_C = H$	

**Commercial Version** (Continued)

**SOIC, PCC and Cerpak AC Electrical Characteristics**

$V_{EE} = -4.2V$  to  $-5.7V$ ,  $V_{CC} = V_{CCA} = GND$  (Continued)

Symbol	Parameter	$T_C = 0^\circ C$		$T_C = +25^\circ C$		$T_C = +85^\circ C$		Units	Conditions
		Min	Max	Min	Max	Min	Max		
$t_{TLH}$ $t_{THL}$	Transition Time 20% to 80%, 80% to 20%	0.35	1.10	0.35	1.10	0.35	1.10	ns	Figures 1, 3 and 4
$t_s$	Setup Time $D_n$	0.30		0.30		0.30		ns	Figure 5
	$CD_n$ , $SD_n$ (Release Time)	1.20		1.20		1.20			Figure 4
	MS, MR (Release Time)	2.20		2.20		2.20			
$t_H$	Hold Time $D_n$	0.5		0.5		0.7		ns	Figure 5
$t_{pw(H)}$	Pulse Width HIGH $CP_n$ , $CP_C$ , $CD_n$ , $SD_n$ , MR, MS	2.00		2.00		2.00		ns	Figures 3 and 4
$t_{PLH}$ $t_{PHL}$	Propagation Delay $CP_C$ to Output	0.75	1.40	0.75	1.40	0.80	1.50	ns	Figures 1 and 3 PCC Only
$t_{PLH}$ $t_{PHL}$	Propagation Delay $CP_n$ to Output	0.70	1.40	0.75	1.40	0.80	1.50		
$t_{PLH}$ $t_{PHL}$	Propagation Delay $CD_n$ , $SD_n$ to Output	0.70	1.50	0.70	1.50	0.80	1.60	ns	Figures 1 and 4
		$t_{PLH}$ $t_{PHL}$	0.80	1.70	0.80	1.70	0.80		
$t_{PLH}$ $t_{PHL}$	Propagation Delay MS, MR to Output	1.10	2.00	1.10	2.00	1.20	2.10	ns	
		$t_{PLH}$ $t_{PHL}$	1.20	2.10	1.20	2.10	1.30		
$t_{OSHL}$	Maximum Skew Common Edge Output-to-Output Variation Common Clock to Output Path		100		100		100	ps	PCC Only (Note 1)
$t_{OSHL}$	Maximum Skew Common Edge Output-to-Output Variation $CP_n$ to Output Path		235		235		235	ps	PCC Only (Note 1)
$t_{OSLH}$	Maximum Skew Common Edge Output-to-Output Variation Common Clock to Output Path		120		120		120	ps	PCC Only (Note 1)
$t_{OSLH}$	Maximum Skew Common Edge Output-to-Output Variation $CP_n$ to Output Path		275		275		275	ps	PCC Only (Note 1)
$t_{OST}$	Maximum Skew Opposite Edge Output-to-Output Variation Common Clock to Output Path		125		125		125	ps	PCC Only (Note 1)
$t_{OST}$	Maximum Skew Opposite Edge Output-to-Output Variation $CP_n$ to Output Path		265		265		265	ps	PCC Only (Note 1)
$t_{ps}$	Maximum Skew Pin (Signal) Transition Variation Common Clock to Output Path		90		90		90	ps	PCC Only (Note 1)
$t_{ps}$	Maximum Skew Pin (Signal) Transition Variation $CP_n$ to Output Path		90		90		90	ps	PCC Only (Note 1)

**Note 1:** Output-to-Output Skew is defined as the absolute value of the difference between the actual propagation delay for any outputs within the same packaged device. The specifications apply to any outputs switching in the same direction either HIGH to LOW ( $t_{OSHL}$ ), or LOW to HIGH ( $t_{OSLH}$ ), or in opposite directions both HL and LH ( $t_{OST}$ ). Parameters  $t_{OST}$  and  $t_{ps}$  guaranteed by design.

## Industrial Version

### PCC DC Electrical Characteristics

$V_{EE} = -4.2V$  to  $-5.7V$ ,  $V_{CC} = V_{CCA} = GND$ ,  $T_C = -40^\circ C$  to  $+85^\circ C$  (Note)

Symbol	Parameter	$T_C = -40^\circ C$		$T_C = 0^\circ C$ to $+85^\circ C$		Units	Conditions	
		Min	Max	Min	Max			
$V_{OH}$	Output HIGH Voltage	-1085	-870	-1025	-870	mV	$V_{IN} = V_{IH} (Max)$ or $V_{IL} (Min)$	Loading with $50\Omega$ to $-2.0V$
$V_{OL}$	Output LOW Voltage	-1830	-1575	-1830	-1620	mV		
$V_{OHC}$	Output HIGH Voltage	-1095		-1035		mV	$V_{IN} = V_{IH} (Min)$ or $V_{IL} (Max)$	Loading with $50\Omega$ to $-2.0V$
$V_{OLC}$	Output LOW Voltage		-1565		-1610	mV		
$V_{IH}$	Input HIGH Voltage	-1170	-870	-1165	-870	mV	Guaranteed HIGH Signal for All Inputs	
$V_{IL}$	Input LOW Voltage	-1830	-1480	-1830	1475	mV	Guaranteed LOW Signal for All Inputs	
$I_{IL}$	Input LOW Current	0.5		0.5		$\mu A$	$V_{IN} = V_{IL} (Min)$	
$I_{IH}$	Input HIGH Current		300		240	$\mu A$	$V_{IN} = V_{IH} (Max)$	
$I_{EE}$	Power Supply Current	-122	-60	-122	-65	mA	Inputs Open	

**Note:** The specified limits represent the "worst case" value for the parameter. Since these values normally occur at the temperature extremes, additional noise immunity and guardbanding can be achieved by decreasing the allowable system operating ranges. Conditions for testing shown in the tables are chosen to guarantee operation under "worst case" conditions.

### PCC AC Electrical Characteristics

$V_{EE} = -4.2V$  to  $-5.7V$ ,  $V_{CC} = V_{CCA} = GND$

Symbol	Parameter	$T_C = -40^\circ C$		$T_C = +25^\circ C$		$T_C = +85^\circ C$		Units	Conditions	
		Min	Max	Min	Max	Min	Max			
$f_{max}$	Toggle Frequency	375		400		400		MHz	Figures 2 and 3	
$t_{PLH}$ $t_{PHL}$	Propagation Delay CP <sub>C</sub> to Output	0.75	1.80	0.75	1.80	0.75	1.80	ns	Figures 1 and 3	
$t_{PLH}$ $t_{PHL}$	Propagation Delay CP <sub>n</sub> to Output	0.70	1.80	0.75	1.80	0.75	1.80	ns		
$t_{PLH}$ $t_{PHL}$	Propagation Delay CD <sub>n</sub> , SD <sub>n</sub> to Output	0.60	1.50	0.70	1.50	0.70	1.60	ns	CP <sub>n</sub> , CP <sub>C</sub> = L	Figures 1 and 4
$t_{PLH}$ $t_{PHL}$		0.70	1.80	0.70	1.80	0.70	1.80		CP <sub>n</sub> , CP <sub>C</sub> = H	
$t_{PLH}$ $t_{PHL}$	Propagation Delay MS, MR to Output	1.10	2.40	1.10	2.40	1.10	2.40	ns	CP <sub>n</sub> , CP <sub>C</sub> = L	
$t_{PLH}$ $t_{PHL}$		1.10	2.60	1.10	2.60	1.10	2.60		CP <sub>n</sub> , CP <sub>C</sub> = H	
$t_{TLH}$ $t_{THL}$	Transition Time 20% to 80%, 80% to 20%	0.20	1.40	0.35	1.10	0.35	1.10	ns	Figures 1, 3 and 4	
$t_S$	Setup Time D <sub>n</sub>	1.00		0.30		0.30		ns	Figure 5	
	CD <sub>n</sub> , SD <sub>n</sub> (Release Time)	1.50		1.20		1.20			Figure 4	
	MS, MR (Release Time)	2.50		2.20		2.20				
$t_H$	Hold Time D <sub>n</sub>	0.7		0.5		0.7		ns	Figure 5	
$t_{pw(H)}$	Pulse Width HIGH CP <sub>n</sub> , CP <sub>C</sub> , CD <sub>n</sub> , SD <sub>n</sub> , MR, MS	2.00		2.00		2.00		ns	Figures 3 and 4	

## Military Version

### DC Electrical Characteristics

$V_{EE} = -4.2V$  to  $-5.7V$ ,  $V_{CC} = V_{CCA} = GND$ ,  $T_C = -55^{\circ}C$  to  $+125^{\circ}C$

Symbol	Parameter	Min	Max	Units	$T_C$	Conditions	Notes	
$V_{OH}$	Output HIGH Voltage	-1025	-870	mV	$0^{\circ}C$ to $+125^{\circ}C$	$V_{IN} = V_{IH} (Max)$ or $V_{IL} (Min)$	Loading with $50\Omega$ to $-2.0V$	1, 2, 3
		-1085	-870	mV	$-55^{\circ}C$			
$V_{OL}$	Output LOW Voltage	-1830	-1620	mV	$0^{\circ}C$ to $+125^{\circ}C$			
		-1830	-1555	mV	$-55^{\circ}C$			
$V_{OHC}$	Output HIGH Voltage	-1035		mV	$0^{\circ}C$ to $+125^{\circ}C$	$V_{IN} = V_{IH} (Min)$ or $V_{IL} (Max)$	Loading with $50\Omega$ to $-2.0V$	1, 2, 3
		-1085		mV	$-55^{\circ}C$			
$V_{OLC}$	Output LOW Voltage		-1610	mV	$0^{\circ}C$ to $+125^{\circ}C$			
			-1555	mV	$-55^{\circ}C$			
$V_{IH}$	Input HIGH Voltage	-1165	-870	mV	$-55^{\circ}C$ to $+125^{\circ}C$	Guaranteed HIGH Signal for all Inputs	1, 2, 3, 4	
$V_{IL}$	Input LOW Voltage	-1830	-1475	mV	$-55^{\circ}C$ to $+125^{\circ}C$	Guaranteed LOW Signal for all Inputs	1, 2, 3, 4	
$I_{IL}$	Input LOW Current	0.50		$\mu A$	$-55^{\circ}C$ to $+125^{\circ}C$	$V_{EE} = -4.2V$ $V_{IN} = V_{IL} (Min)$	1, 2, 3	
$I_{IH}$	Input HIGH Current		240	$\mu A$	$0^{\circ}C$ to $+125^{\circ}C$	$V_{EE} = -5.7V$ $V_{IN} = V_{IH} (Max)$	1, 2, 3	
			340	$\mu A$	$-55^{\circ}C$			
$I_{EE}$	Power Supply Current	-130	-50	mA	$-55^{\circ}C$ to $+125^{\circ}C$	Inputs Open	1, 2, 3	

**Note 1:** F100K 300 Series cold temperature testing is performed by temperature soaking (to guarantee junction temperature equals  $-55^{\circ}C$ ), then testing immediately without allowing for the junction temperature to stabilize due to heat dissipation after power-up. This provides "cold start" specs which can be considered a worst case condition at cold temperatures.

**Note 2:** Screen tested 100% on each device at  $-55^{\circ}C$ ,  $+25^{\circ}C$ , and  $+125^{\circ}C$ , Subgroups, 1, 2, 3, 7 and 8.

**Note 3:** Sampled tested (Method 5005, Table I) on each manufactured lot at  $-55^{\circ}C$ ,  $+25^{\circ}C$ , and  $+125^{\circ}C$ , Subgroups A1, 2, 3, 7 and 8.

**Note 4:** Guaranteed by applying specified input condition and testing  $V_{OH}/V_{OL}$ .

## Military Version (Continued)

### AC Electrical Characteristics

$V_{EE} = -4.2V$  to  $-5.7V$ ,  $V_{CC} = V_{CCA} = GND$

Symbol	Parameter	$T_C = -55^\circ C$		$T_C = +25^\circ C$		$T_C = +125^\circ C$		Units	Conditions		Notes
		Min	Max	Min	Max	Min	Max				
$f_{max}$	Toggle Frequency	400		400		400		MHz	Figures 2 and 3		4
$t_{PLH}$ $t_{PHL}$	Propagation Delay $CP_C$ to Output	0.50	2.20	0.60	2.00	0.50	2.40	ns	Figures 1 and 3		1, 2, 3
$t_{PLH}$ $t_{PHL}$	Propagation Delay $CP_n$ to Output	0.50	2.20	0.60	2.00	0.50	2.40	ns			
$t_{PLH}$ $t_{PHL}$	Propagation Delay $CD_n$ , $SD_n$ to Output	0.50	2.20	0.60	2.00	0.50	2.40	ns	$CP_n$ , $CP_C = L$	Figures 1 and 4	
$t_{PLH}$ $t_{PHL}$		0.50	2.40	0.60	2.10	0.50	2.50				
$t_{PLH}$ $t_{PHL}$	Propagation Delay $MS$ , $MR$ to Output	0.70	2.70	0.80	2.60	0.80	2.90	ns	$CP_n$ , $CP_C = L$		
$t_{PLH}$ $t_{PHL}$		0.70	2.90	0.80	2.80	0.80	3.10		$CP_n$ , $CP_C = H$		
$t_{TLH}$ $t_{THL}$	Transition Time 20% to 80%, 80% to 20%	0.20	1.40	0.20	1.40	0.20	1.40	ns	Figures 1, 3 and 4		
$t_s$	Setup Time $D_n$	1.00		0.80		0.90		ns	Figure 5		4
	$CD_n$ , $SD_n$ (Release Time)	1.50		1.30		1.60			Figure 4		
	$MS$ , $MR$ (Release Time)	2.50		2.30		2.50					
$t_h$	Hold Time $D_n$	1.50		1.30		1.60		ns	Figure 5		
$t_{pw(H)}$	Pulse Width HIGH $CP_n$ , $CP_C$ , $CD_n$ , $SD_n$ , $MR$ , $MS$	2.00		2.00		2.00		ns	Figures 3 and 4		

**Note 1:** F100K 300 Series cold temperature testing is performed by temperature soaking (to guarantee junction temperature equals  $-55^\circ C$ ), then testing immediately without allowing for the junction temperature to stabilize due to heat dissipation after power-up. This provides "cold start" specs which can be considered a worst case condition at cold temperatures.

**Note 2:** Screen tested 100% on each device at  $+25^\circ C$ . Temperature only, Subgroup A9.

**Note 3:** Sample tested (Method 5005, Table I) on each Mfg. lot at  $+25^\circ C$ , Subgroup A9, and at  $+125^\circ C$ , and  $-55^\circ C$  Temp., Subgroups A10 and A11.

**Note 4:** Not tested at  $+25^\circ C$ ,  $+125^\circ C$  and  $-55^\circ C$  Temperature (design characterization data).



## Test Circuits

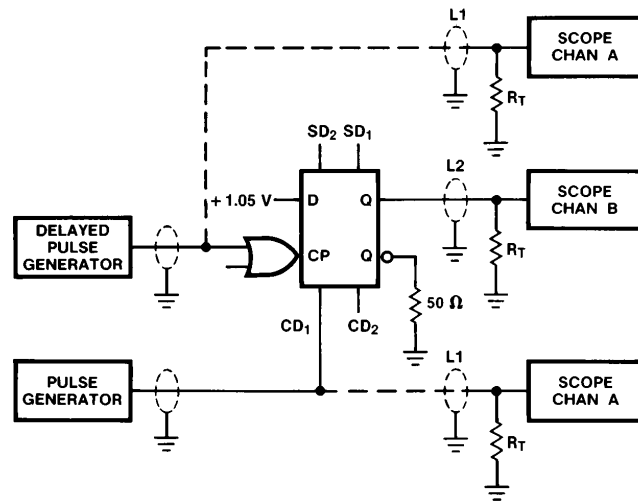


FIGURE 1. AC Test Circuit

TL/F/10262-6

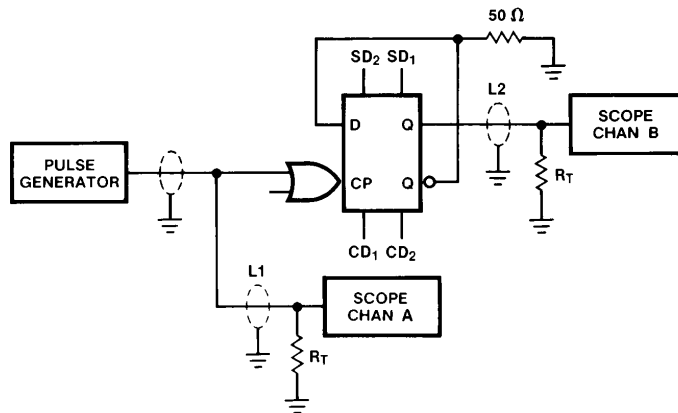


FIGURE 2. Toggle Frequency Test Circuit

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**Notes:**

$V_{CC}, V_{CCA} = +2V, V_{EE} = -2.5V$

L1 and L2 = Equal length 50 $\Omega$  impedance lines

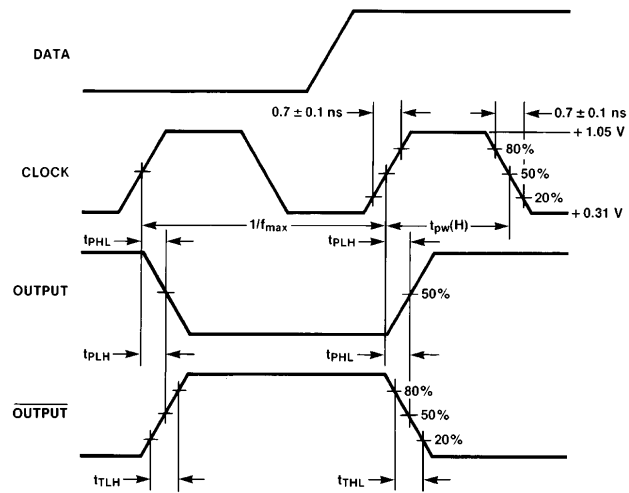
$R_T = 50\Omega$  terminator internal to scope

Decoupling 0.1  $\mu F$  from GND to  $V_{CC}$  and  $V_{EE}$

All unused outputs are loaded with 50 $\Omega$  to GND

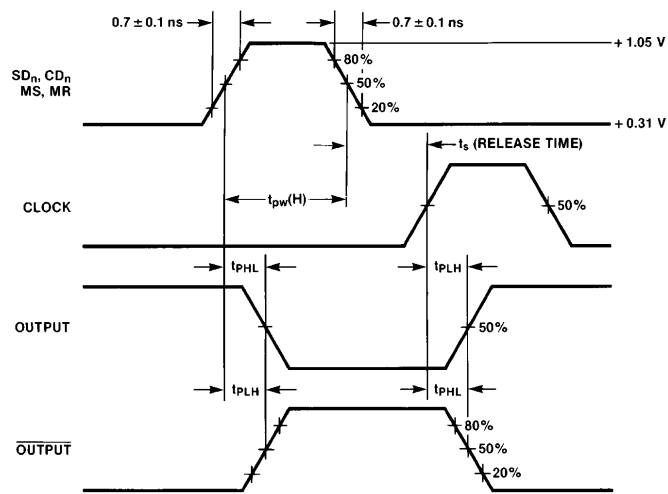
$C_L$  = Fixture and stray capacitance  $\leq 3$  pF

## Switching Waveforms



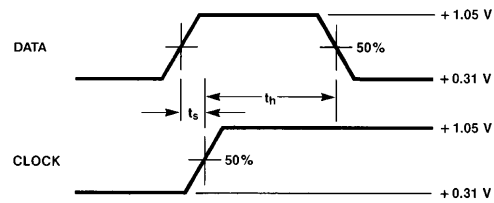
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FIGURE 3. Propagation Delay (Clock) and Transition Times



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FIGURE 4. Propagation Delay (Resets)



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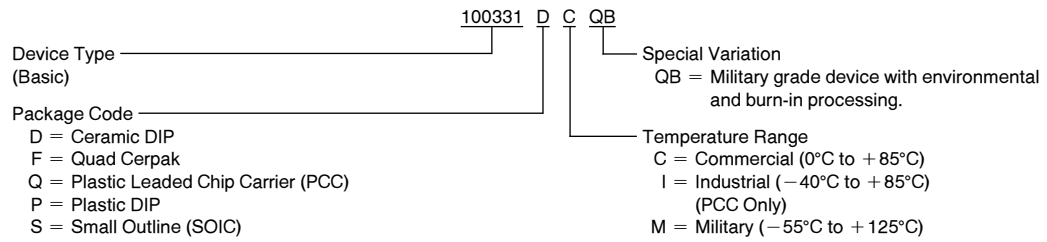
FIGURE 5. Data Setup and Hold Time

**Note:**  $t_s$  is the minimum time before the transition of the clock that information must be present at the data input.

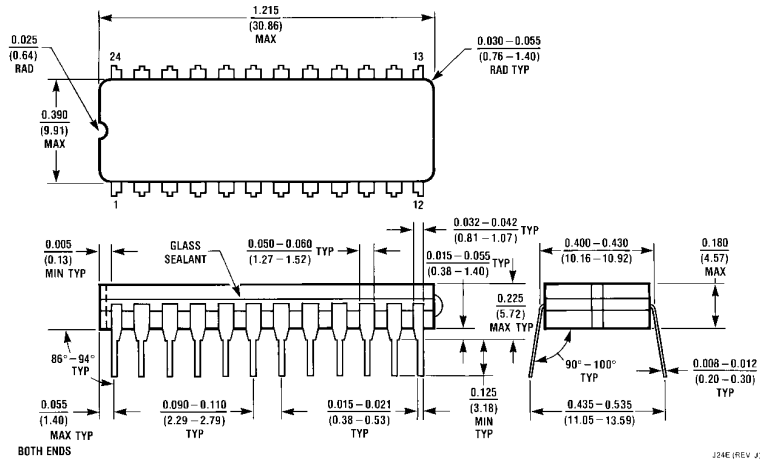
**Note:**  $t_h$  is the minimum time after the transition of the clock that information must remain unchanged at the data input.

## Ordering Information

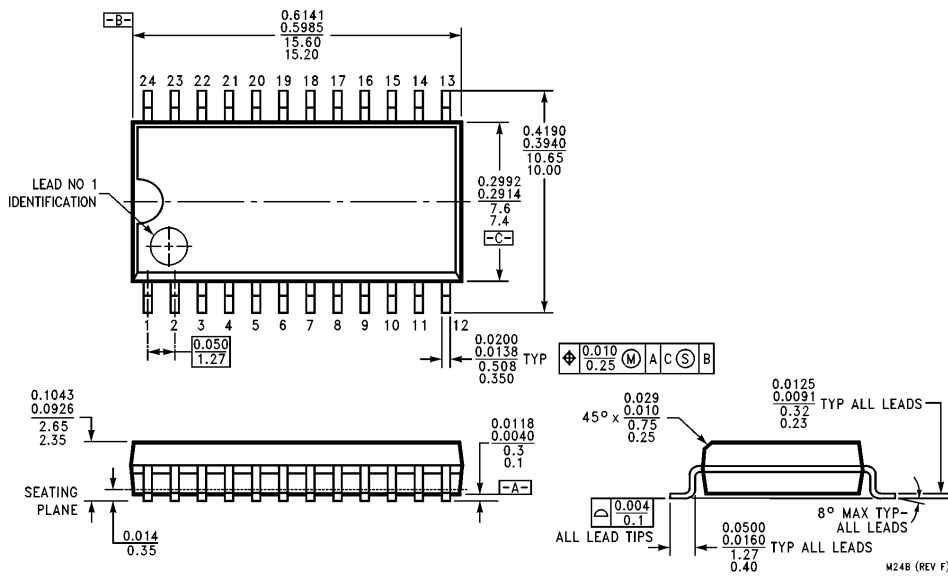
The device number is used to form part of a simplified purchasing code where a package type and temperature range are defined as follows:



**Physical Dimensions** inches (millimeters)

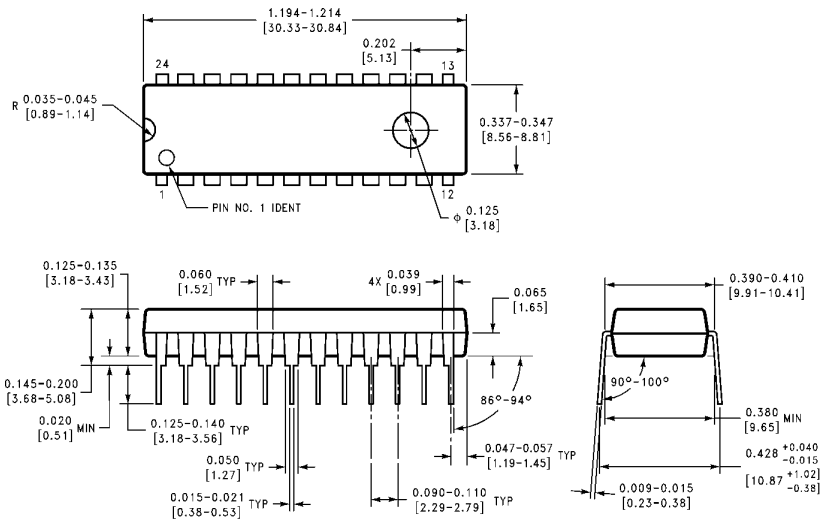


**24-Lead Ceramic Dual-In-Line Package (0.400" Wide) (D)**  
NS Package Number J24E



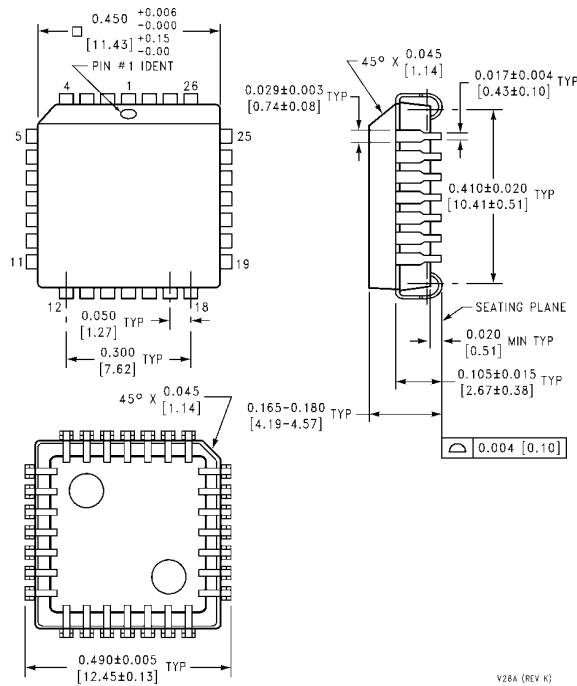
**24-Lead Molded Package (0.300" Wide) (S)**  
NS Package Number M24B

**Physical Dimensions** inches (millimeters) (Continued)



**24-Lead Plastic Dual-In-Line Package (P)**  
NS Package Number N24E

N24E (REV A)

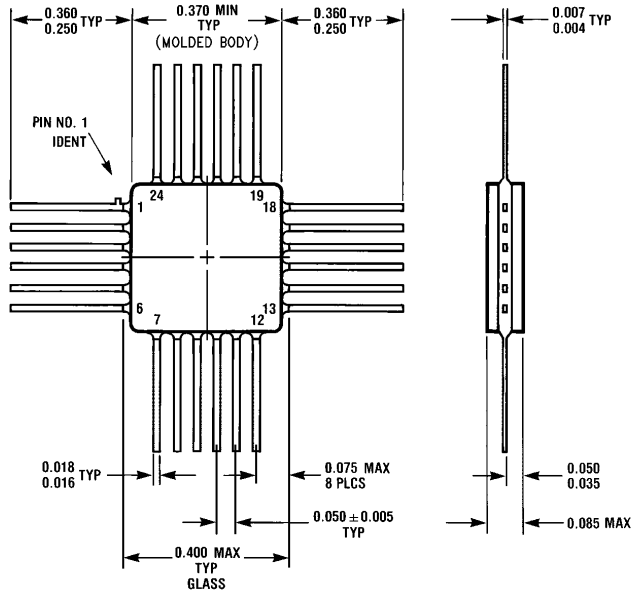


**28-Lead Plastic Chip Carrier (Q)**  
NS Package Number V28A

V28A (REV K)

**Physical Dimensions** inches (millimeters) (Continued)

Lit. # 114912



W24B (REV D)

**24-Lead Quad Cerpak (F)  
NS Package Number W24B**

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



**National Semiconductor Corporation**  
1111 West Bardin Road  
Arlington, TX 76017  
Tel: 1(800) 272-9959  
Fax: 1(800) 737-7018

**National Semiconductor Europe**  
Fax: (+49) 0-180-530 85 86  
Email: cnjwge@tevm2.nsc.com  
Deutsch Tel: (+49) 0-180-530 85 85  
English Tel: (+49) 0-180-532 78 32  
Français Tel: (+49) 0-180-532 93 58  
Italiano Tel: (+49) 0-180-534 16 80

**National Semiconductor Hong Kong Ltd.**  
19th Floor, Straight Block,  
Ocean Centre, 5 Canton Rd.  
Tsimshatsui, Kowloon  
Hong Kong  
Tel: (852) 2737-1600  
Fax: (852) 2736-9960

**National Semiconductor Japan Ltd.**  
Tel: 81-043-299-2309  
Fax: 81-043-299-2408